

RGTH00TK65D

650V 50A Field Stop Trench IGBT

V _{CES}	650V
I _{C(100°C)}	21A
V _{CE(sat) (Typ.)}	1.6V@I _C =50A
P_D	72W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating; RoHS Compliant

Applications

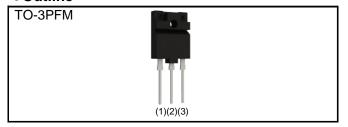
PFC

UPS

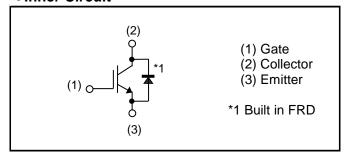
Power Conditioner

ΙH

Outline



●Inner Circuit



Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Tuno	Tape Width (mm)	-
Туре	Basic Ordering Unit (pcs)	450
	Packing Code	C11
	Marking	RGTH00TK65D

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Value	Unit
Collector - Emitter Voltage		650	V
	V_{GES}	±30	V
T _C = 25°C	I _C	35	А
T _C = 100°C	I _C	21	А
	I _{CP} *1	200	А
T _C = 25°C	I _F	34	А
T _C = 100°C	I _F	19	А
Diode Pulsed Forward Current		200	А
Power Dissipation $T_C = 25^{\circ}C$		72	W
T _C = 100°C	P _D	36	W
Operating Junction Temperature		-40 to +175	°C
Storage Temperature		-55 to +175	°C
	$T_{C} = 100^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$ $T_{C} = 25^{\circ}C$	$T_{C} = 25^{\circ}C \qquad I_{C}$ $T_{C} = 100^{\circ}C \qquad I_{C}$ I_{CP}^{*1} $T_{C} = 25^{\circ}C \qquad I_{F}$ $T_{C} = 100^{\circ}C \qquad I_{F}$ I_{FP}^{*1} $T_{C} = 25^{\circ}C \qquad P_{D}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

^{*1} Pulse width limited by T_{jmax.}

●Thermal Resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	2.07	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	3.09	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit	
raiametei	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_C = 10 \mu A, V_{GE} = 0 V$	650	1	-	V	
Collector Cut - off Current	I _{CES}	$V_{CE} = 650V, V_{GE} = 0V$	ı	1	10	μΑ	
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, \ V_{CE} = 0V$	-	-	±200	nA	
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 34.7 \text{mA}$	4.5	5.5	6.5	V	
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 50A$, $V_{GE} = 15V$ $T_j = 25$ °C $T_j = 175$ °C	-	1.6 2.1	2.1	V	

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Darameter	Symbol	Ol Conditions -		Unit		
Parameter	Symbol		Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	V _{CE} = 30V	-	2740	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$	-	106	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	43	-	
Total Gate Charge	Q_g	V _{CE} = 300V	-	94	-	
Gate - Emitter Charge	Q_ge	I _C = 50A	-	22	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	31	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 50A, V_{CC} = 400V$	-	39	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	63	-	
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	143	-	ns
Fall Time	t _f	Inductive Load	-	50	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 50A, V_{CC} = 400V$	-	39	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	63	-	20
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	159	-	ns
Fall Time	t _f	Inductive Load	-	62	-	
		$I_C = 200A, V_{CC} = 520V$				
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650 V, V_{GE} = 15 V$	FU	LL SQUA	RE	-
		$R_G = 60\Omega, T_j = 175^{\circ}C$				

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Darameter	Symbol	Conditions	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward Voltage	V _F	$I_F = 30A$ $T_j = 25$ °C $T_j = 175$ °C	-	1.45 1.25	2.0	V
Diode Reverse Recovery Time	t _{rr}	I _F = 30A	-	54	ı	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 25^{\circ}C$	-	7.4	-	А
Diode Reverse Recovery Charge	Q_{rr}		-	0.22	-	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 30A	-	225	ı	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$	-	12.8	1	А
Diode Reverse Recovery Charge	Q_{rr}	T _j = 175°C	-	1.60	-	μC

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Fig.1 Power Dissipation vs. Case Temperature

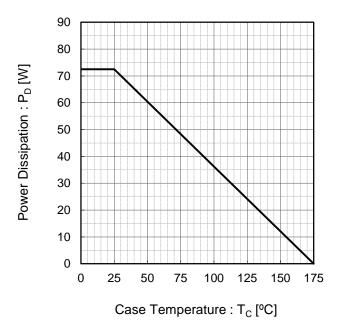
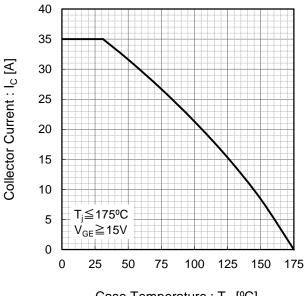


Fig.2 Collector Current vs. Case Temperature



Case Temperature : T_C [°C]

Fig.3 Forward Bias Safe Operating Area

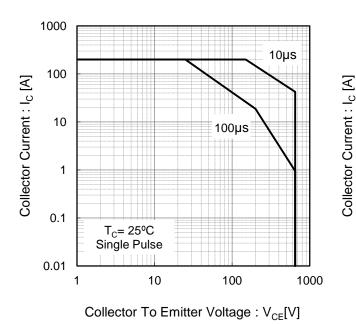
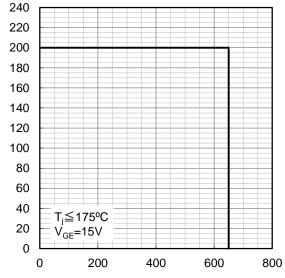


Fig.4 Reverse Bias Safe Operating Area



Collector To Emitter Voltage : $V_{CE}[V]$

Fig.5 Typical Output Characteristics

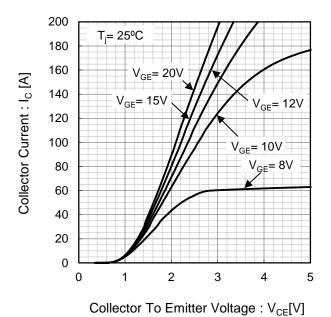
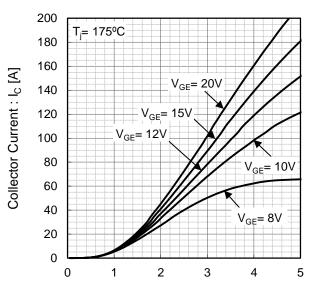


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage: V_{CE}[V]

Fig.7 Typical Transfer Characteristics

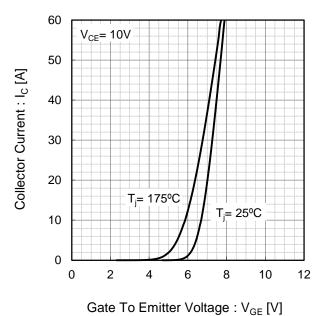
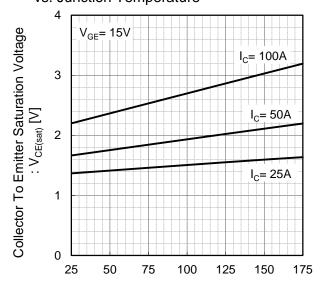


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



Junction Temperature : T_i [°C]

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

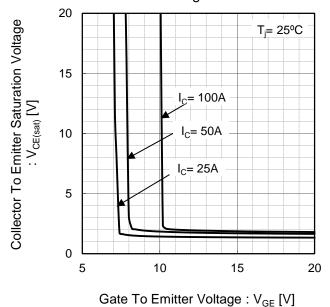
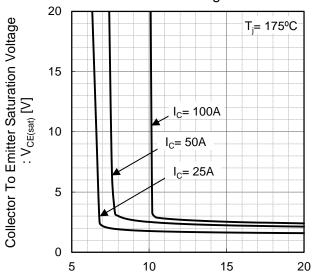


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage: V_{GE} [V]

vs. Collector Current $t_{d(off)}$ $t_{d(off)}$ $t_{d(on)}$ $v_{CC}=400V, V_{GE}=15V$ $R_{G}=10\Omega, T_{j}=175^{\circ}C$ Inductive load 0 10 20 30 40 50 60 70 80 90 100

Collector Current : I_C [A]

Fig.11 Typical Switching Time

Fig.12 Typical Switching Time vs. Gate Resistance 1000 Switching Time [ns] 100 t_{d(on)} $V_{CC} = 400V, I_{C} = 50A$ V_{GE}=15V, T_i=175°C Inductive load 10 10 40 0 20 30 50

Gate Resistance : $R_G[\Omega]$

Fig.13 Typical Switching Energy Losses vs. Collector Current

10 E_{on} 0.1 E_{on} $V_{cc}=400V, V_{gE}=15V$ $E_{gE}=100, T_{j}=175^{\circ}C$ Inductive load

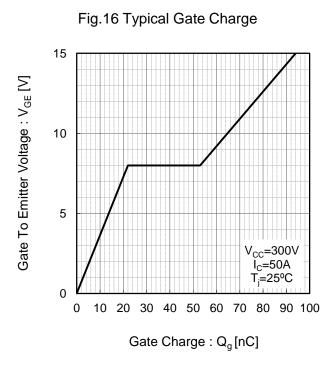
0 10 20 30 40 50 60 70 80 90 100

Collector Current : I_{c} [A]

vs. Gate Resistance 10 Switching Energy Losses [mJ] $\mathsf{E}_{\mathsf{off}}$ 1 E_{on} 0.1 V_{CC} =400V, I_{C} =50A V_{GE} =15V, T_{j} =175°C Inductive load 0.01 0 10 20 30 40 50 Gate Resistance : $R_G[\Omega]$

Fig.14 Typical Switching Energy Losses

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] Coes 100 Cres 10 f=1MHz $V_{GE}=0V$ T;=25°C 0.01 0.1 10 100 Collector To Emitter Voltage : V_{CE}[V]



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Fig.17 Typical Diode Forward Current vs. Forward Voltage 200 180 160 Forward Current : I_F [A] 140 120 100 80 60 T_i= 175°C 40 T_i= 25°C 20 0 3.5 0.5 1.5 2 2.5 3 0 Forward Voltage : V_F[V]

Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current 400 V_{CC} =400V di_F/dt=200A/µs Reverse Recovery Time: t_{rr} [ns] Inductive load 300 T_i= 175°C 200 100 T_i= 25°C 0 10 20 30 40 50 0 Forward Current : I_F [A]

Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

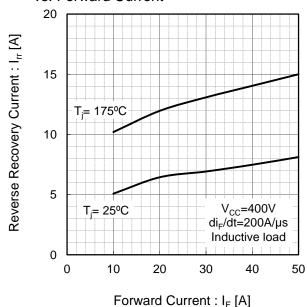


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current

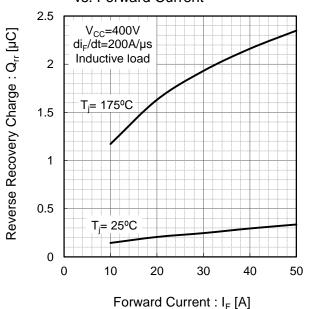
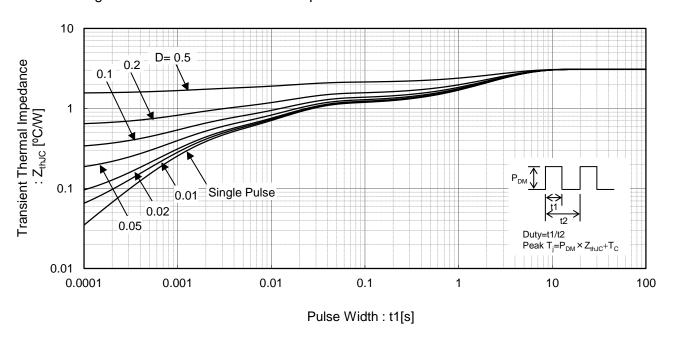


Fig.21 IGBT Transient Thermal Impedance



Fig.22 Diode Transient Thermal Impedance



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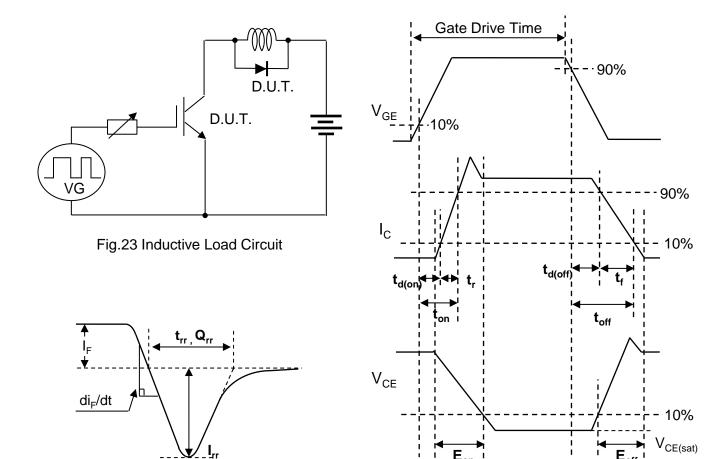


Fig.25 Diode Reverce Recovery Waveform

Fig.24 Inductive Load Waveform

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Distribution Inventory

Part Number	rgth00tk65d
Package	TO-3PFM
Unit Quantity	450
Minimum Package Quantity	450
Packing Type	Tube
Constitution Materials List	inquiry
RoHS	Yes